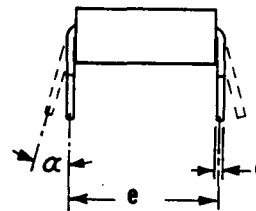
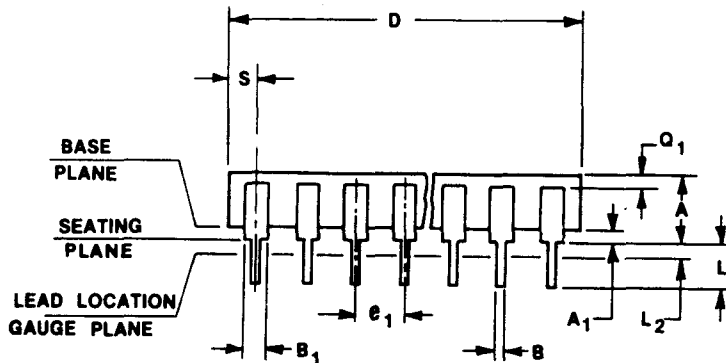
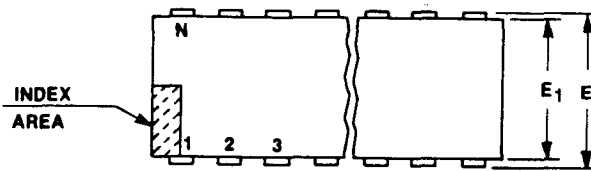
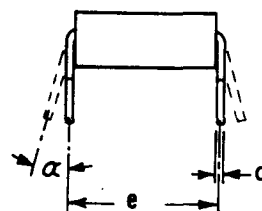
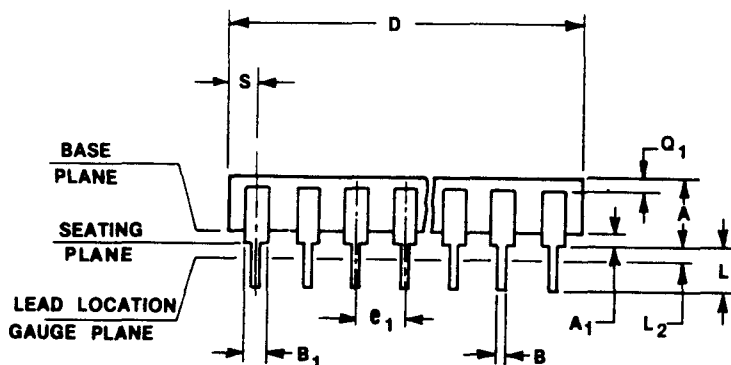
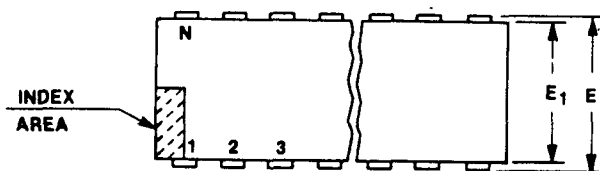


NOTES:

1. Refer to applicable symbol list.
2. Dimensioning and tolerancing per ANSI Y14.5-1973.
3. Leads within .13mm (.005 in.) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
4. e_1 and e_A applies in zone L_2 when unit installed.
5. α applies to spread leads prior to installation.
6. N is the number of terminal positions.
7. Outlines on which the seating plane is coincident with the base plane ($A_1 = 0$), terminals lead standoffs are not required, and B_1 may equal B along any part of the lead above the seating/base plane.
8. E_1 does not include particles of package materials.
9. This dimension shall be measured with the device seated in the seating plane gauge JEDEC Outline No. GS-3.
10. Controlling Dimension: INCH.



S y m b o l	Variations (ALL DIMENSIONS SHOWN IN MILLIMETERS)											
	AA		N o t e			N o t e			N o t e			N o t e
	Min.	Max.		Min.	Max.		Min.	Max.		Min.	Max.	
A	2.29	4.44	9									
A ₁	.64	1.39	9									
B	.381	.584										
B ₁	.97	1.52										
C	.204	.304										
D	26.42	28.44										
E	10.04	10.66										
E ₁	9.66	10.41	8									
E ₁	2.54 TP		3.4									
E _A	10.16 TP											
L	3.18	4.44	9									
L ₂	.00	.76										
α	0°	15°										
N	22											
Q ₁	.25	---										
S	.89	1.65										
Note	1,2,10											
Ref.												
Issue	A APRIL 1981											
JEDEC Solid State Product Outlines			Title CERAMIC SIDE LEADED DUAL IN LINE (DIP) FAMILY 10.16 ROW SPACING				Issue A		Date APRIL 1981		MO-037	



NOTES:

1. Refer to applicable symbol list.
2. Dimensioning and tolerancing per ANSI Y14.5-1973.
3. Leads within .13mm (.005 in.) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
4. e_1 and e_A applies in zone L_2 when unit installed.
5. α applies to spread leads prior to installation.
6. N is the number of terminal positions.
7. Outlines on which the seating plane is coincident with the base plane ($A_1 = 0$), terminals lead standoffs are not required, and B, may equal B along any part of the lead above the seating/base plane.
8. E_1 does not include particles of package materials.
9. This dimension shall be measured with the device seated in the seating plane gauge JEDEC Outline No. GS-3.
10. Controlling Dimension: INCH.

Variations (ALL DIMENSIONS SHOWN IN INCHES)

Symbol	Variations (ALL DIMENSIONS SHOWN IN INCHES)											
	AA		Note			Note			Note			Note
	Min.	Max.		Min.	Max.		Min.	Max.		Min.	Max.	
A	.090	.175	9									
A ₁	.025	.055	9									
B	.015	.023										
B ₁	.038	.060										
C	.008	.012										
D	1.040	1.120										
E	.395	.420										
E ₁	.380	.410	8									
E ₁	.100 TP		3,4									
E _A	.400 TP		3,4									
L	.125	.175	9									
L ₂	.000	.030										
α	0°	15°										
N	22											
Q ₁	.010	---										
S	.035	.065										
Note	1,2,10											
Ref.												
Issue	A APRIL 1981											
JEDEC Solid State Product Outlines			Title CERAMIC SIDE LEADED DUAL IN LINE (DIP) FAMILY .400 ROW SPACING				Issue A	Date APRIL 1981	MO-037			